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JAN 25 2007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	: 09/884,429	Confirmation No.:	9951
Applicant(s)	: David Chazan et al.		
Filing Date	: 06/18/2001		
TC/A.U.	: 1743		
Examiner	: Brian R. Gordon		
Docket No.	: 100/09110		
Customer No.	: 021569		
Title	: Methods and Devices for Enhancing Bonded Substrate Yields and Regulating Temperature		

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE

Sir:

In response to the final Office action mailed October 25, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.

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